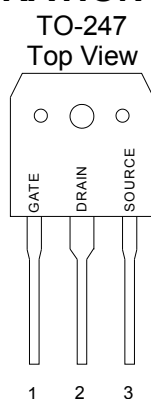




### GENERAL DESCRIPTION

This high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

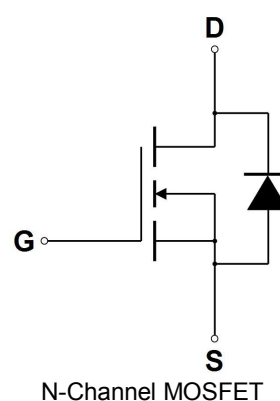
### PIN CONFIGURATION



### FEATURES

- ◆ Robust High Voltage Termination
- ◆ Avalanche Energy Specified
- ◆ Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- ◆ Diode is Characterized for Use in Bridge Circuits
- ◆  $I_{DSS}$  and  $V_{DS(on)}$  Specified at Elevated Temperature
- ◆ Isolated Mounting Hole Reduces Mounting Hardware

### SYMBOL



### ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain to Current — Continuous	$I_{D(1)}$	75.3	A
— Pulsed	$I_{DM}$	225.9	A
Gate-to-Source Voltage — Continue	$V_{GS}$	$\pm 20$	V
Total Power Dissipation —TO-247	$P_D$	595	W
Derate above 25°C —TO-247		4.76	W/°C
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C
Single Pulse Drain-to-Source Avalanche Energy — $T_J = 25^\circ\text{C}$ ( $V_{DD} = 100\text{V}$ , $V_{GS} = 10\text{V}$ , $I_L = 17\text{A}$ , $L = 20\text{mH}$ , $R_G = 25\Omega$ )	$E_{AS}$	2890	mJ
Thermal Resistance — Junction to Case -TO-247	$\theta_{JC}$	0.21	°C/W
— Junction to Ambient -TO-247	$\theta_{JA}$	40	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	$T_L$	260	°C

(1) Drain current limited by maximum junction temperature



### ORDERING INFORMATION

Part Number	TOP MARK	Part Number	Packing Mthod	Note
GWM76S60XN247 (Notte1)	GWM76S60X	TO-247	Tube	
GWM76S60GN247 (Notte2)	GWM76S60G	TO-247	Tube	

**Note1:** X : Suffix for Halogen Free Product,

**Note2:** G : Suffix for PB Free Product,

### ELECTRICAL CHARACTERISTICS

Unless otherwise specified,  $T_J = 25^{\circ}\text{C}$ .

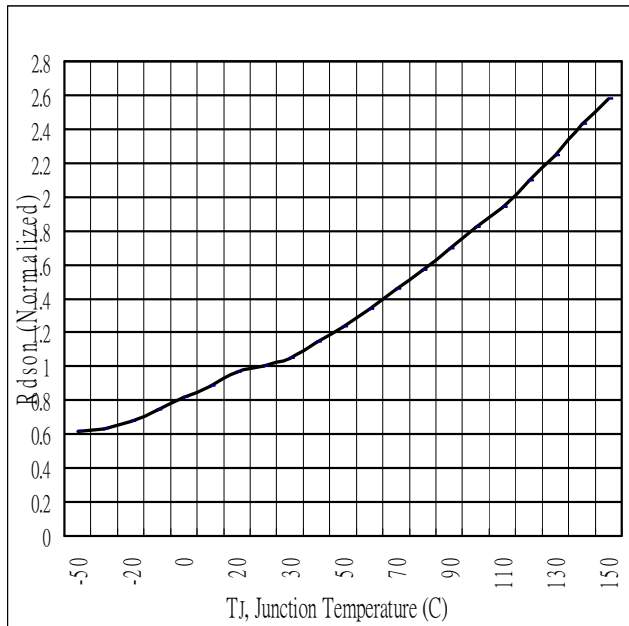
		GWM76S60				
Characteristic		Symbol	Min	Typ	Max	Units
Drain-Source Breakdown Voltage (V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA)		V <sub>(BR)DSS</sub>	600			V
Drain-Source Leakage Current (V <sub>DS</sub> =600 V, V <sub>GS</sub> = 0 V)		I <sub>DSS</sub>			1	uA
Gate-Source Leakage Current-Forward (V <sub>gsf</sub> = 20 V, V <sub>DS</sub> = 0 V)		I <sub>GSSF</sub>			100	nA
Gate-Source Leakage Current-Reverse (V <sub>gsr</sub> = - 20 V, V <sub>DS</sub> = 0 V)		I <sub>GSSR</sub>			100	nA
Gate Threshold Voltage (V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA)		V <sub>GS(th)</sub>	2	3	4	V
Static Drain-Source On-Resistance (V <sub>GS</sub> = 10 V, I <sub>D</sub> = 25.4A) *		R <sub>DS(on)</sub>		36	42	mΩ
Input Capacitance	(V <sub>DS</sub> =100 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz)	C <sub>iss</sub>		6078		pF
Output Capacitance		C <sub>oss</sub>		247		pF
Reverse Transfer Capacitance		C <sub>rss</sub>		25		pF
Turn-On Delay Time	(V <sub>DD</sub> = 300 V, I <sub>D</sub> =76 A, R <sub>G</sub> = 25Ω) *	t <sub>d(on)</sub>		48.9		ns
Rise Time		t <sub>r</sub>		115.2		ns
Turn-Off Delay Time		t <sub>d(off)</sub>		179.9		ns
Fall Time		t <sub>f</sub>		113.2		ns
Total Gate Charge	(V <sub>DS</sub> = 480 V, I <sub>D</sub> = 76 A, V <sub>GS</sub> = 10 V)*	Q <sub>g</sub>		143.9		nC
Gate-Source Charge		Q <sub>gs</sub>		39.5		nC
Gate-Drain Charge		Q <sub>gd</sub>		60.0		nC
SOURCE-DRAIN DIODE CHARACTERISTICS						
Forward On-Voltage(1)	(I <sub>S</sub> = 76 A, d <sub>IS</sub> /d <sub>t</sub> = 100A/μs)	V <sub>SD</sub>			1.5	V
Forward Turn-On Time		t <sub>on</sub>		**		ns
Reverse Recovery Time		t <sub>rr</sub>		627		ns

\* Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$

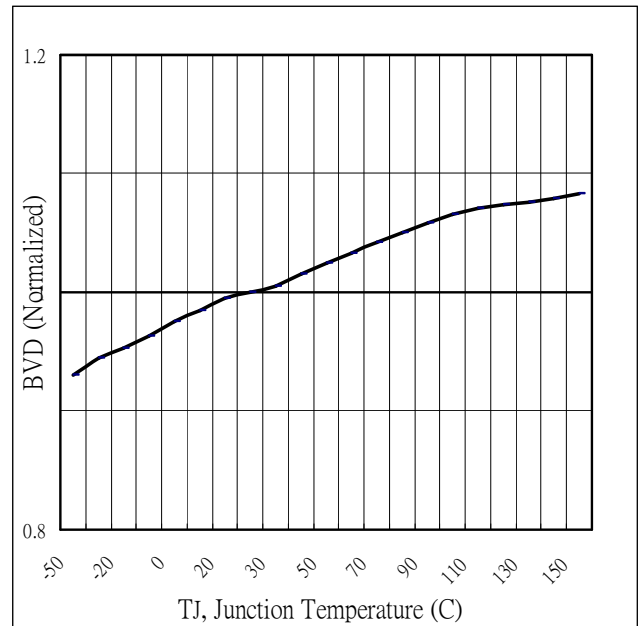
\*\* Negligible, Dominated by circuit inductance



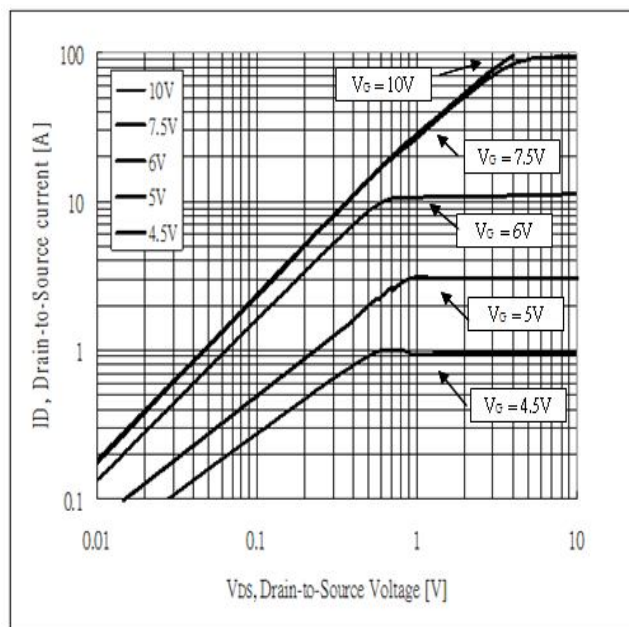
### TYPICAL ELECTRICAL CHARACTERISTICS



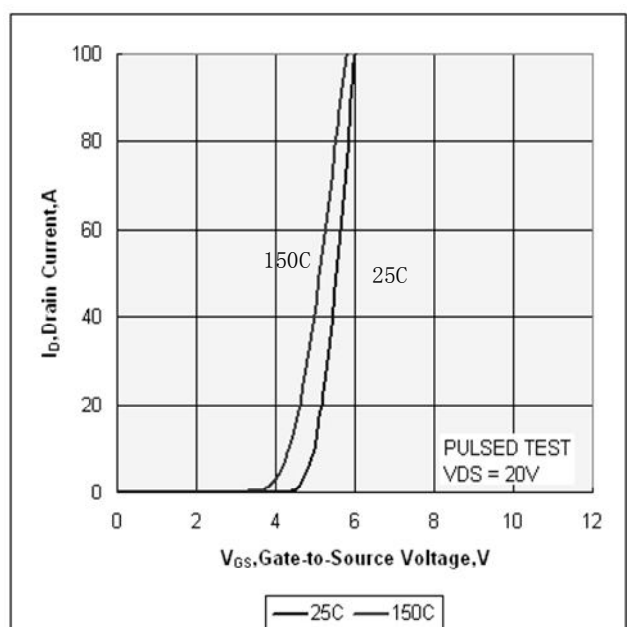
**Fig 1. On-Resistance Variation with vs. Temperature**



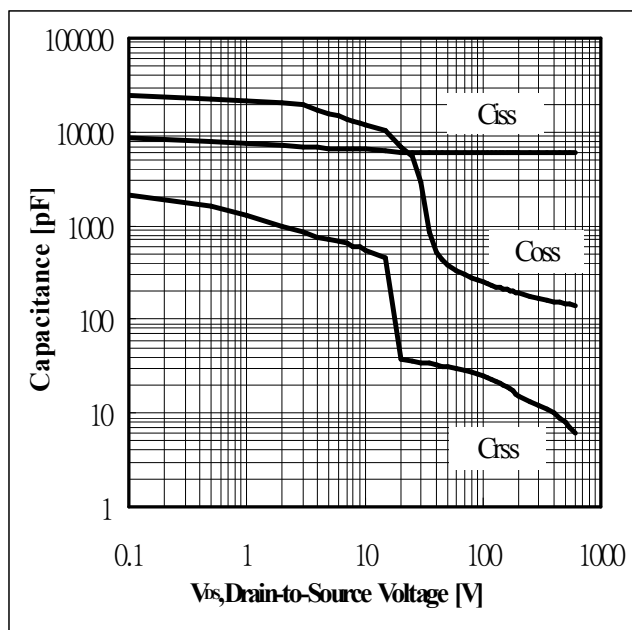
**Fig.2 Breakdown Voltage Variation vs. Temperature**



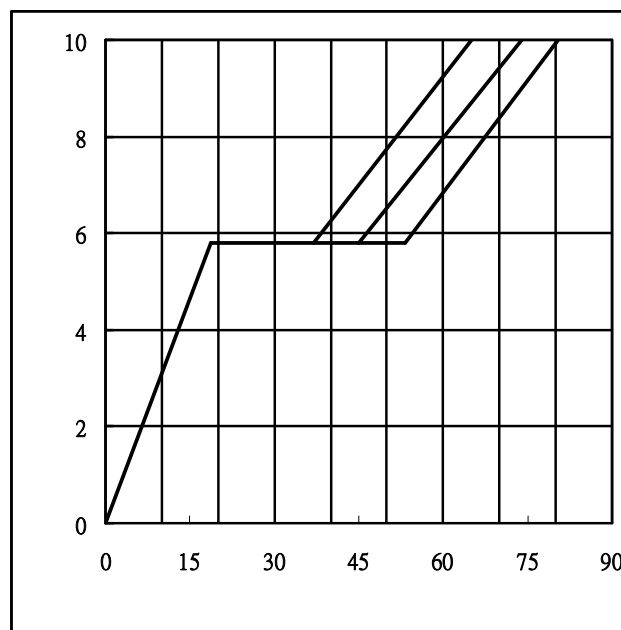
**Fig 3. Typical Output Characteristics**



**Fig 4. Typical Transfer Characteristics**



**Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage**



**Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage**